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EUROPEAN PATENT APPLICATION

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(54) METHOD OF CLEANING A VIA HOLE

(57) In a method of manufacturing a semiconductor device having a multi-layer interconnection, after a via hole has been formed, the inside of the via hole is cleaned using a cleaning solution containing a complexing agent capable of forming a complex with contaminants of copper type metals.



EUROPEAN SEARCH REPORT

Application Number EP 99 11 9623

ategory	Citation of document with ind	lication, where appropriate,	Relevant	CLASSIFICATION OF THE APPLICATION (Int.CI.7)	
Υ .	of relevant passage EP 0 678 571 A (BAKE 25 October 1995 (199 * page 1, line 1 - p	R J T INC) 5-10-25) age 4, line 6 *	1,2,4,5, 10	H01L21/3105	
Y	* page 10, line 40 - US 5 354 712 A (HO Y 11 October 1994 (199 * column 5, line 53 figures 1A-1G *	U Q ET AL)	1,2,4,5,		
A	US 5 451 551 A (KRIS 19 September 1995 (1	HNAN AJAY ET AL) 995-09-19)			
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	The present search report has b				
	Place of search	Date of completion of the sear 10 December 1		etticher, H =	
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Application Number

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CLAIMS INCURRING FEES
The present European patent application comprised at the time of filing more than ten claims.
Only part of the daims have been paid within the prescribed time limit. The present European search report has been drawn up for the first ten claims and for those claims for which claims fees have been paid, namely claim(s):
No claims fees have been paid within the prescribed time limit. The present European search report has been drawn up for the first ten claims.
LACK OF UNITY OF INVENTION
The Search Division considers that the present European patent application does not comply with the requirements of unity of invention and relates to several inventions or groups of inventions, namely:
see sheet B
All further search fees have been paid within the fixed time limit. The present European search report has been drawn up for all claims.
As all searchable claims could be searched without effort justifying an additional fee, the Search Division did not invite payment of any additional fee.
Only part of the further search fees have been paid within the fixed time limit. The present European search report has been drawn up for those parts of the European patent application which relate to the inventions in respect of which search fees have been paid, namely claims:
None of the further search fees have been paid within the fixed time limit. The present European search report has been drawn up for those parts of the European patent application which relate to the invention first mentioned in the claims, namely claims:

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LACK OF UNITY OF INVENTION SHEET B

Application Number

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The Search Division considers that the present European patent application does not comply with the requirements of unity of invention and relates to several inventions or groups of inventions, namely:

1. Claims: 1,2,4,5,10

A via hole dry etched through an insulating film to a copper containing wiring is cleaned from metallic contaminants by a cleaning solution containing a complexing agent such as a polyaminocarboxylic acid like EDTA or a carboxylic acid like citric acid.

This is obvious from EP-A-0 678 571 page 3 last paragraph and Example 6.

2. Claim: 3

The complexing agent contains a polyaminocarboxylic acid and a carboxylic acid.

3. Claim: 6

The insulating film is an SOG film.

4. Claim: 7

The insulating film is an HSQ film.

5. Claim: 8

After dry etching and before cleaning a solution containing an amine compound is applied to the via hole.

6. Claim: 9

The cleaning solution further contains an amine compound.

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ANNEX TO THE EUROPEAN SEARCH REPORT ON EUROPEAN PATENT APPLICATION NO.

EP 99 11 9623

This annex lists the patent family members relating to the patent documents cited in the above-mentioned European search report. The members are as contained in the European Patent Office EDP file on The European Patent Office is in no way liable for these particulars which are merely given for the purpose of information.

10-12-1999

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For more details about this annex : see Official Journal of the European Patent Office, No. 12/82

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